PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|------------|----------------|
| CHI CAO | 04/01/2021 |
| KANGMIN HU | 04/01/2021 |

RECEIVING PARTY DATA

| Name: | INNOGRIT TECHNOLOGIES CO., LTD. | |
|-------------------|---|--|
| Street Address: | LANE 500 SHENGXIA ROAD, ZHANGJIANG, PUDONG NEW AREA | |
| Internal Address: | BUILDING 1, FLOOR 2 | |
| City: | SHANGHAI | |
| State/Country: | CHINA | |
| Postal Code: | 201210 | |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 17326548 |

CORRESPONDENCE DATA

Fax Number: (312)616-5700

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 3126165600

Email: assignments@leydig.com
Correspondent Name: LEYDIG, VOIT & MAYER, LTD.

Address Line 1: TWO PRUDENTIAL PLAZA, SUITE 4900

Address Line 2: 180 NORTH STETSON AVENUE Address Line 4: CHICAGO, ILLINOIS 606016731

| ATTORNEY DOCKET NUMBER: | 818156 |
|-------------------------|-------------------|
| NAME OF SUBMITTER: | JAMES C. SIGNOR |
| SIGNATURE: | /James C. Signor/ |
| DATE SIGNED: | 05/25/2021 |

Total Attachments: 2

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PATENT 506679928 REEL: 056335 FRAME: 0683

Attorney Docket No. 818156 (Client Ref. P2021-0063)

ASSIGNMENT

I, Chi Cao, having an address at Building 1; Floor 2; Lane 500 Shengxia Road;

Zhangjiang; Pudong New Area; Shanghai 201210; CHINA; and

I, Kangmin Hu, having an address at Building 1; Floor 2; Lane 500 Shengxia Road;

Zhangjiang; Pudong New Area; Shanghai 201210; CHINA

and each of us, if more than one person is identified above, have invented and have owned or

do own a whole or partial right, title and interest in a certain invention entitled:

OSCILLATOR CIRCUIT

described in the patent application bearing the above Attorney Docket No. and title and

WHEREAS,

INNOGRIT TECHNOLOGIES CO., LTD.

having an address at Building 1; Floor 2; Lane 500 Shengxia Road; Zhangjiang;

Pudong New Area; Shanghai 201210; CHINA,

hereinafter referred to as Assignee, was and/or is desirous of acquiring the entire domestic

and foreign right, title, and interest in and under the invention described in the above patent

application.

Now, THEREFORE, for good and valuable consideration, the receipt and sufficiency

of which are hereby acknowledged, Assignor has assigned or hereby does assign and transfer

to the Assignee and the Assignee's legal representatives, successors and assigns my/our full

and exclusive rights in and to the invention in the U.S. and every foreign country and my/our

entire right, title, and interest in and to the patent application and other such applications

(e.g., provisional applications, non-provisional applications, continuations, continuations-in-

part, divisionals, reissues, reexaminations, National phase applications, including petty patent

applications, and utility model applications) that may be filed in the United States and every

foreign country on the invention, and the patents, extensions, or derivations thereof, both

foreign and domestic, that may issue thereon, and I/we do hereby authorize and request the

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PATENT REEL: 056335 FRAME: 0684

Attorney Docket No. 818156 (Client Ref. P2021-0063)

Commissioner of Patents to issue U.S. patents to the above-mentioned Assignee agreeably

with the terms of this assignment document.

UPON SAID CONSIDERATION, I/we have conveyed or hereby do convey to the Assignee the right to make application in its own behalf for protection of the invention in the U.S. and countries foreign to the U.S. and to claim under the Patent Cooperation Treaty, the International Convention and/or other international arrangement for any such application the date of the U.S. application (or any other application on the invention) to gain priority with

respect to other applications.

any writing or do any act whatsoever conflicting with the terms of this assignment document set forth herein, and that I/we will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to perfect the Assignee's enjoyment of this assignment, and render all necessary assistance in making application for and obtaining original, continuation, continuation-in-part, divisional, reissued, reexamined, and National phase patents of the U.S. or of any and all foreign

I/WE DO HEREBY COVENANT and agree with the Assignee that I/we will not execute

countries on the invention, and in enforcing any rights or choses in action accruing as a result of such applications or patents, and by executing statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of,

the assigns and legal representatives of all parties hereto.

Date 4/1/2021
Date 4/1/2021

Chi Cao, Inventor

CHI CAO

RECORDED: 05/25/2021

Kangmin Hu, Inventor